DATA SHEET

NEC

LASER DIODE

NX8341,NX8343,NX8344 Series

1 310 nm AlGaInAs MQW-DFB LASER DIODE FOR 10 Gb/s APPLICATION

DESCRIPTION

The NX8341, NX8343, and NX8344 Series are 1 310 nm Multiple Quantum Wells (MQW) structured Distributed Feed-Back (DFB) laser diode TOSA (transmitter optical subassembly) with InGaAs monitor PIN-PD in a receptacle type package designed for XENPAK/XPAK/X2/XFP transceiver.

APPLICATIONS

- 10 G BASE-LW/LR
- 10 G Fibre Channel
- <R> SONET OC-192

FEATURES

- Internal optical isolator
- Optical output power P_f = –2 dBm
- Low threshold current I_{th} = 8 mA TYP. @ T_C = 25°C
- Wide operating temperature range T_C = –5 to +85°C
- InGaAs monitor PIN-PD

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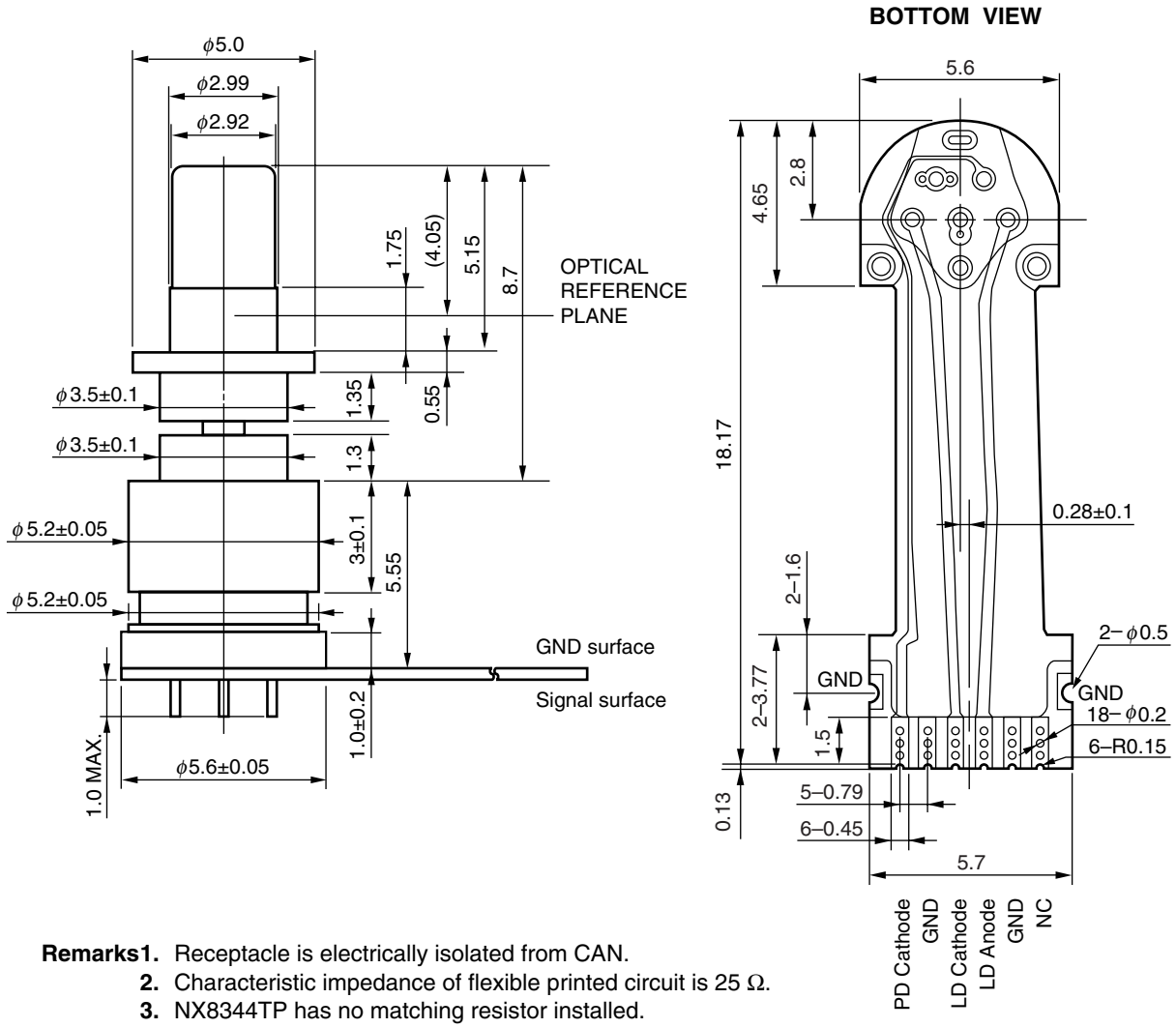
The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

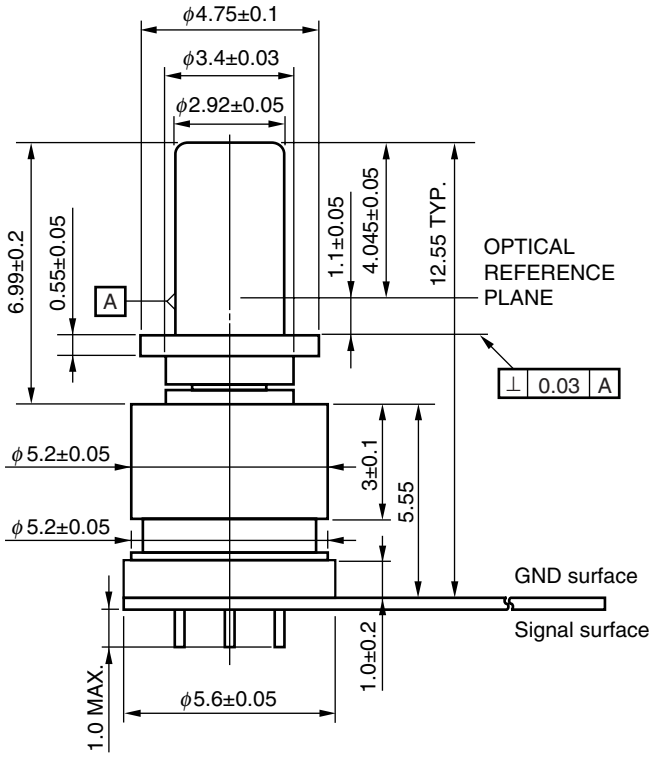
<R> **PACKAGE DIMENSIONS (UNIT : mm)**

NX8343TB/NX8344TP

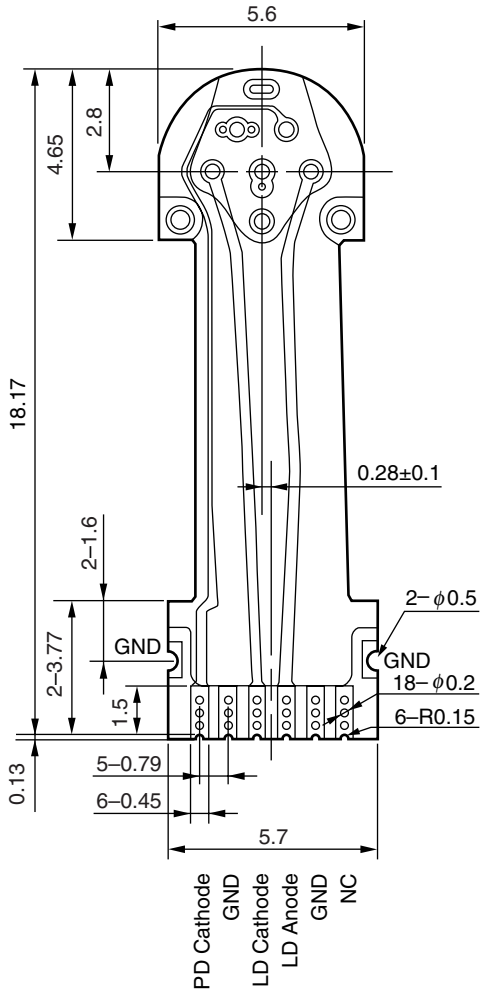


Remarks1. Receptacle is electrically isolated from CAN.
2. Characteristic impedance of flexible printed circuit is 25 Ω.
3. NX8344TP has no matching resistor installed.
4. ( ) indicates nominal dimension.

NX8341TJ

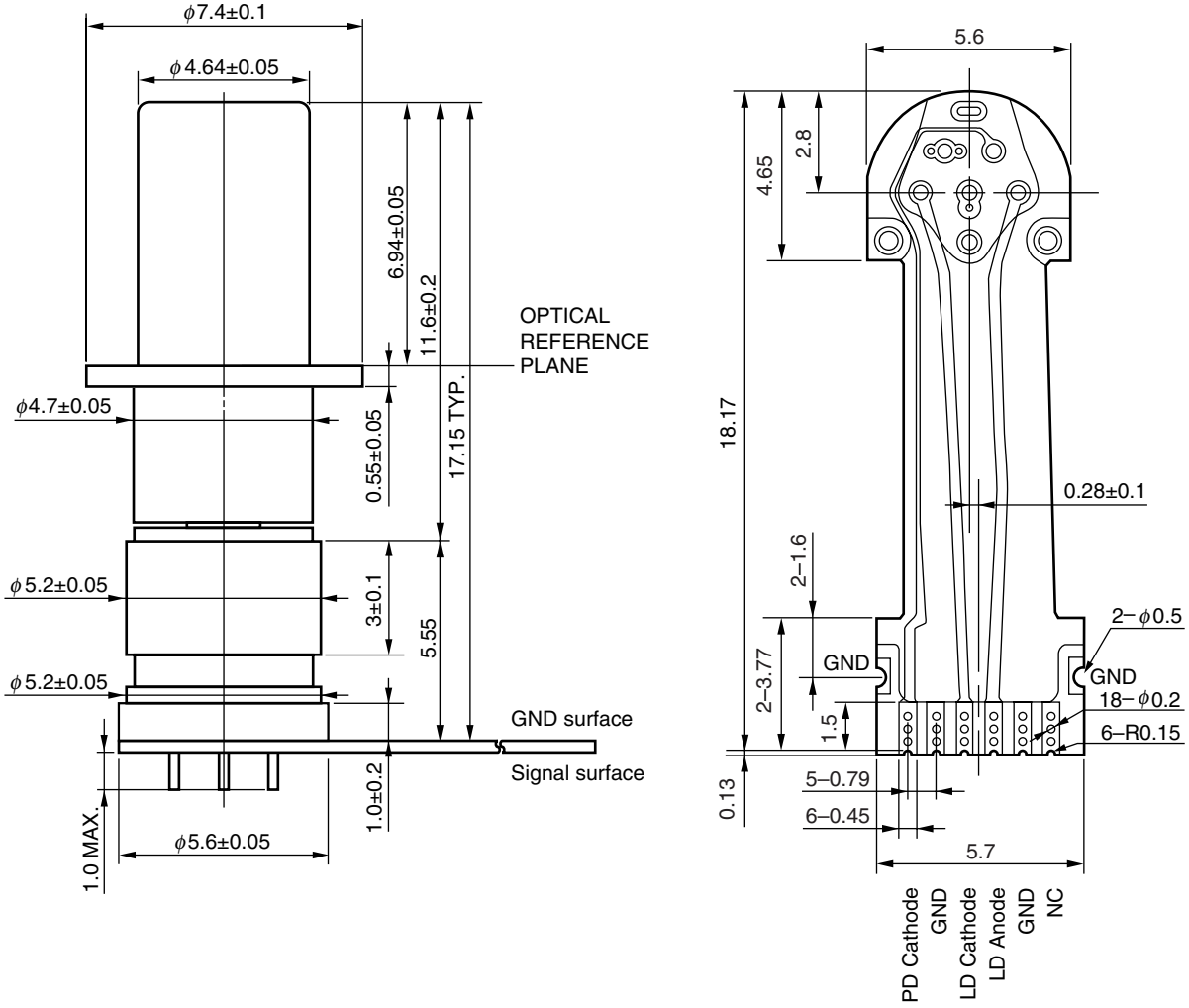


BOTTOM VIEW



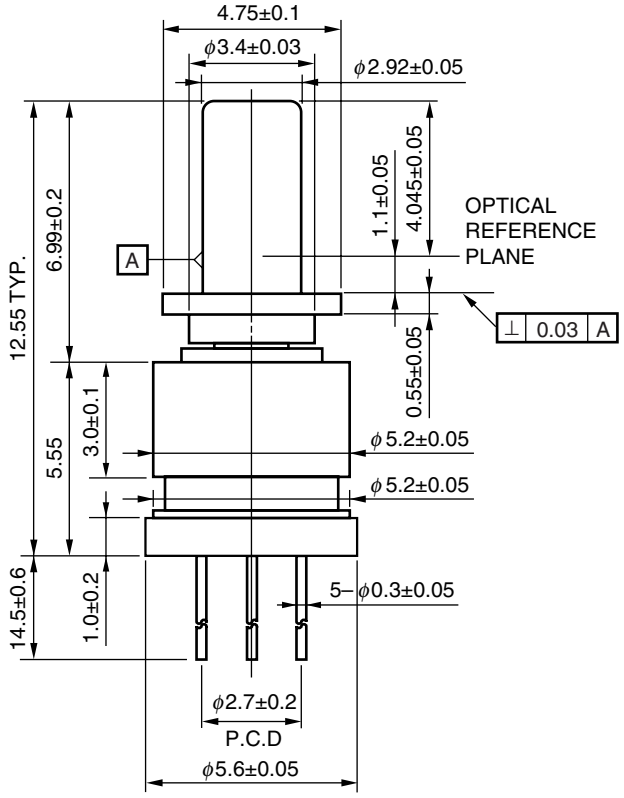
Remark Characteristic impedance of flexible printed circuit is 25 Ω.

NX8341TL

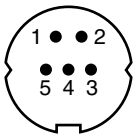


Remark Characteristic impedance of flexible printed circuit is 25 Ω.

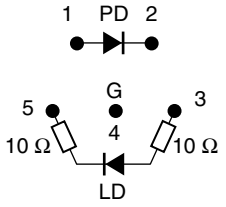
NX8341UJ



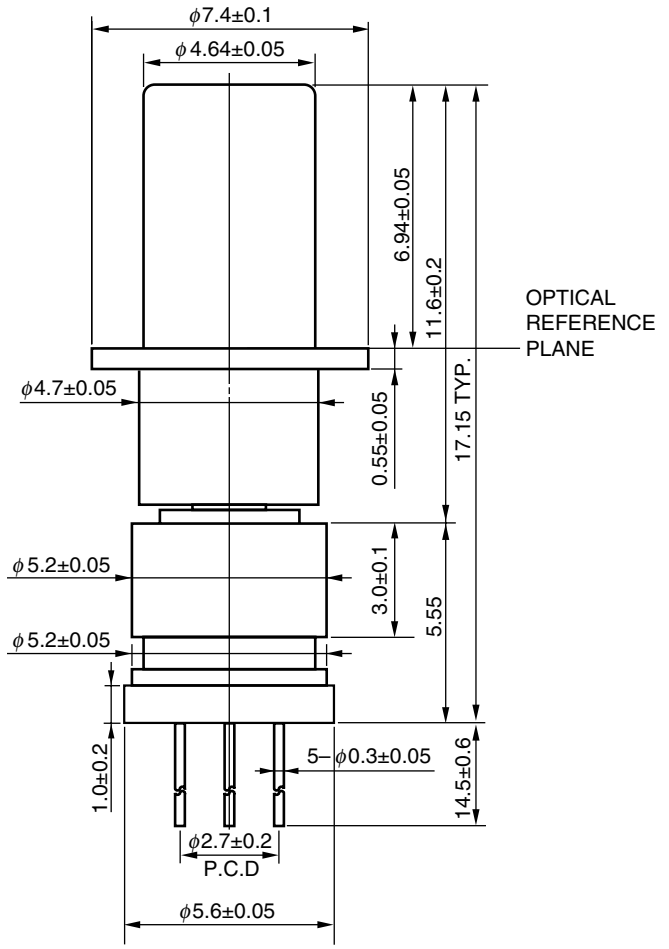
BOTTOM VIEW



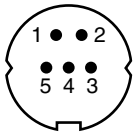
PIN CONNECTIONS



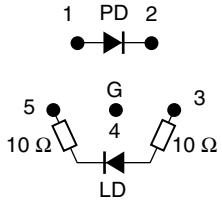
NX8341UL



BOTTOM VIEW



PIN CONNECTIONS



<R> ORDERING INFORMATION

Part Number	Receptacle Type	Note
NX8341TJ	LC	Differential input with flexible PCB
NX8341TL	SC	Differential input with flexible PCB
NX8341UJ	LC	Differential input, 5-pin
NX8341UL	SC	Differential input, 5-pin
NX8343TB	LC, Electrically isolated	Differential input with flexible PCB
NX8344TP	LC, Electrically isolated	Differential input with flexible PCB, without matching resistor

ABSOLUTE MAXIMUM RATINGS

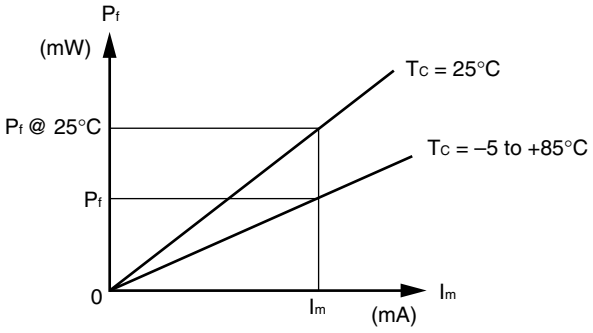
Parameter	Symbol	Ratings	Unit
Storage Temperature	T_{stg}	−40 to +85	°C
Operating Case Temperature	T_C	−5 to +85	°C
Forward Current of LD	I_{FLD}	120	mA
Reverse Voltage of LD	V_{RLD}	2	V
Forward Current of PD	I_{FPD}	10	mA
Reverse Voltage of PD	V_{RPD}	20	V
<R> Lead Soldering Temperature	T_{sld}	350 (3 sec.)	°C
Optical Output Power	P_f	5	mW

ELECTRO-OPTICAL CHARACTERISTICS (T_C = –5 to +85°C, BOL, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Mean Optical Output Power	P_f			–2		dBm
	Peak Emission Wavelength	λ_p	CW, P_f = –2 dBm	1 290		1 330	nm
	Side Mode Suppression Ratio	SMSR	CW, P_f = –2 dBm	30			dB
	Threshold Current	I_{th}	CW, T_C = 25°C		8	20	mA
			CW	2		40	
	Differential Efficiency	η_d	CW, P_f = –2 dBm, T_C = 25°C	0.02	0.025	0.04	W/A
			CW, P_f = –2 dBm	0.005		0.05	
	Operation Voltage	V_{op}	CW, P_f = –2 dBm			2	V
<R>	Monitor Current	I_m	P_f = –2 dBm, V_R = 1.5 V	90		700	μA
	Monitor Dark Current	I_D	V_R = 1.5 V, T_C = 25°C			5	nA
			V_R = 1.5 V			50	
	Rise Time	t_r	20-80% ***1**		30	50	ps
	Fall Time	t_f	20-80% ***1**		40	50	ps
<R>	Extinction Ratio	Ex	10 GbE, 10 G FC	4	5		dB
			SONET OC-192	6	7		
	Tracking Error***2**	γ		–1.0		1.0	dB
	Input Impedance	Z_{in}			25		Ω
	Connector Repeatability	CR	With master pigtail	–1.0		1.0	dB

***1** 9.95/10.3/10.5 Gb/s, PRBS 2^{31}–1, NRZ, Duty Cycle = 50%

***2** Tracking Error: γ



$$\gamma = \left| 10 \log \frac{P_f}{P_f \text{ @ } 25°C} \right| \text{ [dB]}$$

REFERENCE

Document Name	Document No.
Opto-Electronics Devices Pamphlet	PX10160E

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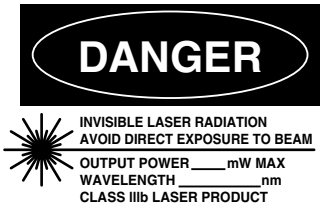
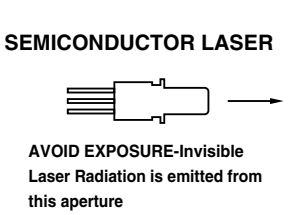
SAFETY INFORMATION ON THIS PRODUCT





Warning Laser Beam	A laser beam is emitted from this diode during operation. The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight. • Do not look directly into the laser beam. • Avoid exposure to the laser beam, any reflected or collimated beam.
Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.
Caution Optical Fiber	A glass-fiber is attached on the product. Handle with care. • When the fiber is broken or damaged, handle carefully to avoid injury from the damaged part or fragments.